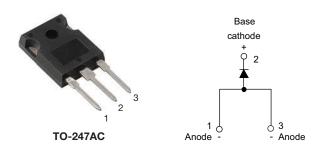


VS-80APS...PbF Series, VS-80APS...-M3 Series

Vishay Semiconductors

High Voltage, Input Rectifier Diode, 80 A



| PRODUCT SUMMARY | | | | |
|----------------------------------|-----------------|--|--|--|
| Package | TO-247AC | | | |
| I _{F(AV)} | 80 A | | | |
| V_{R} | 800 V to 1200 V | | | |
| V _F at I _F | 1.17 V | | | |
| I _{FSM} | 1500 A | | | |
| T _J max. | 150 °C | | | |
| Diode variation | Single die | | | |

FEATURES

- Very low forward voltage drop
- 150 °C max. operating junction temperature
- · Glass passivated pellet chip junction
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





COMPLIANT
HALOGEN
FREE
Available

APPLICATIONS

- Input rectification
- Vishay Semiconductors switches and output rectifiers which are available in identical package outlines

DESCRIPTION

High voltage rectifiers optimized for very low forward voltage drop with moderate leakage.

These devices are intended for use in main rectification (single or three phase bridge).

| MAJOR RATINGS AND CHARACTERISTICS | | | | | | |
|-----------------------------------|------------------------------|-------------|-------|--|--|--|
| SYMBOL | CHARACTERISTICS | VALUES | UNITS | | | |
| I _{F(AV)} | Sinusoidal waveform | 80 | А | | | |
| V _{RRM} | Range | 800/1200 | V | | | |
| I _{FSM} | | 1500 | А | | | |
| V _F | 80 A, T _J = 25 °C | 1.17 | V | | | |
| T _J | | -40 to +150 | °C | | | |

| VOLTAGE RATINGS | | | | | |
|------------------------------|---|--|-------------------------------------|--|--|
| PART NUMBER | V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V | V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V | I _{RRM} AT 150 °C mA | | |
| VS-80APS08PbF, VS-80APS08-M3 | 800 | 900 | 1.5 | | |
| VS-80APS12PbF, VS-80APS12-M3 | 1200 | 1300 | 1.5 | | |

| ABSOLUTE MAXIMUM RATINGS | | | | | | |
|-------------------------------------|--------------------|--|---------|------------------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | |
| Maximum average forward current | I _{F(AV)} | $T_C = 100 ^{\circ}C$, 180° conduction half sine wave | 80 | | | |
| Maximum peak one cycle | | 10 ms sine pulse, rated V _{RRM} applied | 1450 | А | | |
| non-repetitive surge current | IFSM | 10 ms sine pulse, no voltage reapplied | 1500 | | | |
| Maximum I ² t for fusing | I ² t | 10 ms sine pulse, rated V _{RRM} applied | 10 500 | A ² s | | |
| Maximum i-t for fusing | | 10 ms sine pulse, no voltage reapplied | 14 000 | A-5 | | |
| Maximum l²√t for fusing | I ² √t | t = 0.1 ms to 10 ms, no voltage reapplied | 140 000 | A²√s | | |



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| ELECTRICAL SPECIFICATIONS | | | | | |
|----------------------------------|----------------|------------------------------|---|------|-------|
| PARAMETER | SYMBOL | SYMBOL TEST CONDITIONS | | | UNITS |
| Maximum forward voltage drop | V_{FM} | 80 A, T _J = 25 °C | | 1.17 | V |
| Forward slope resistance | r _t | T 150 °C | | 3.17 | mΩ |
| Threshold voltage | $V_{F(TO)}$ | T _J = 150 °C | | 0.73 | V |
| Maximum reverse leakage current | 1 | T _J = 25 °C | V _R = Rated V _{RRM} | 0.1 | mA |
| waxiinum reverse leakage current | IRM | T _J = 150 °C | V _R = nated V _{RRM} | 1.5 | IIIA |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | |
|---|---------|-----------------------------------|--|------------|------------|
| PARAMETER | | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Maximum junction and storage temperature range |) | T _J , T _{Stg} | | -40 to 150 | °C |
| Maximum thermal resistance, junction to case | | R_{thJC} | DC operation | 0.35 | |
| Maximum thermal resistance, junction to ambient | | R_{thJA} | | 40 | °C/W |
| Typical thermal resistance, case to heatsink | | R _{thCS} | Mounting surface, flat, smooth and greased | 0.2 | |
| Approximate weight | | | | 6 | g |
| Approximate weight | | | | 0.21 | oz. |
| Mounting torque | minimum | | | 6 (5) | kgf ⋅ cm |
| Mounting torque — | maximum | | | 12 (10) | (lbf ⋅ in) |
| Marking device | | | Coop at the TO 247AC (IEDEC) | 80APS08 | |
| | | | Case style TO-247AC (JEDEC) | 80APS12 | |

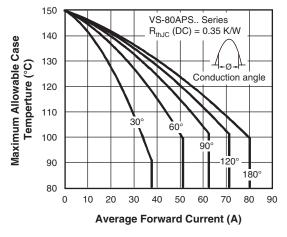


Fig. 1 - Current Rating Characteristics

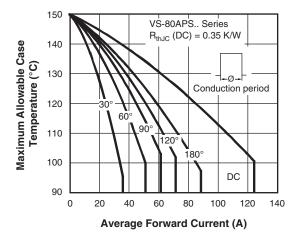


Fig. 2 - Current Rating Characteristics

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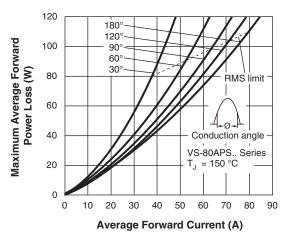


Fig. 3 - Forward Power Loss Characteristics

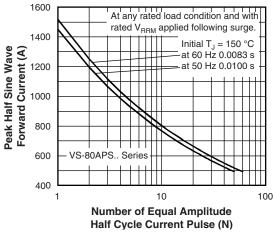


Fig. 5 - Maximum Non-Repetitive Surge Current

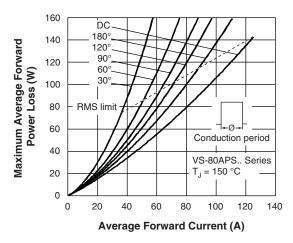


Fig. 4 - Forward Power Loss Characteristics

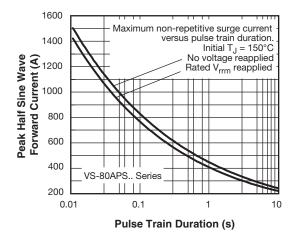


Fig. 6 - Maximum Non-Repetitive Surge Current

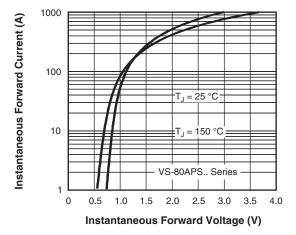


Fig. 7 - Forward Voltage Drop Characteristics

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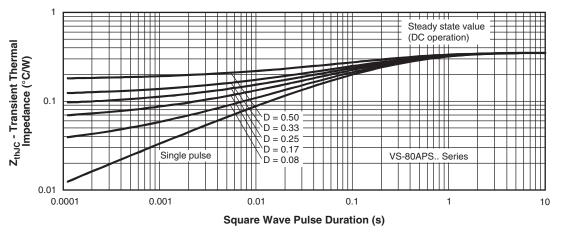
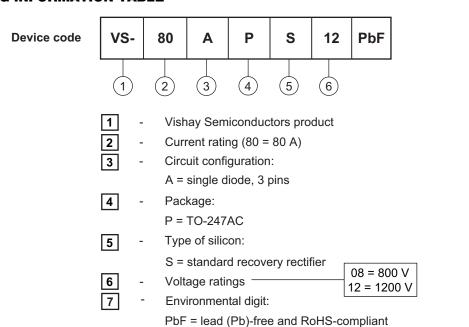


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE



| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|------------------|------------------------|--------------------------|--|--|--|
| PREFERRED P/N | QUANTITY PER T/R | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION | | | |
| VS-80APS08PbF | 25 | 500 | Antistatic plastic tubes | | | |
| VS-80APS08-M3 | 25 | 500 | Antistatic plastic tubes | | | |
| VS-80APS12PbF | 25 | 500 | Antistatic plastic tubes | | | |
| VS-80APS12-M3 | 25 | 500 | Antistatic plastic tubes | | | |

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

| LINKS TO RELATED DOCUMENTS | | | | |
|----------------------------|-----------------------|--------------------------|--|--|
| Dimensions | | www.vishay.com/doc?95542 | | |
| Part marking information | TO-247AC modified PbF | www.vishay.com/doc?95226 | | |
| | TO-247AC modified -M3 | www.vishay.com/doc?95007 | | |
| SPICE model | | www.vishay.com/doc?95550 | | |

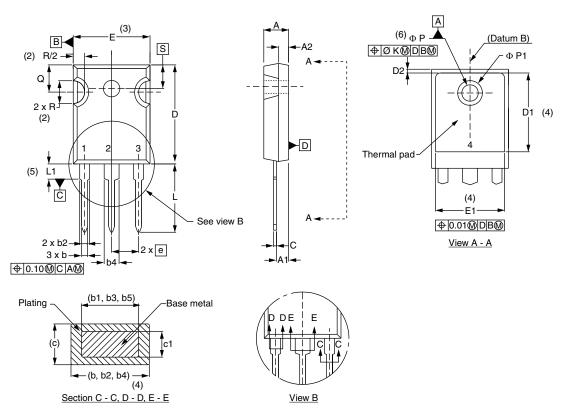
Revision: 11-Feb-16 4 Document Number: 93794



Vishay Semiconductors

TO-247AC - 50 mils L/F

DIMENSIONS in millimeters and inches



| SYMBOL | MILLIN | IETERS | INC | HES | NOTES |
|---------|--------|--------|-------|-------|-------|
| OTHIDOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Α | 4.65 | 5.31 | 0.183 | 0.209 | |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 | |
| A2 | 1.17 | 1.37 | 0.046 | 0.054 | |
| b | 0.99 | 1.40 | 0.039 | 0.055 | |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 | |
| b2 | 1.65 | 2.39 | 0.065 | 0.094 | |
| b3 | 1.65 | 2.34 | 0.065 | 0.092 | |
| b4 | 2.59 | 3.43 | 0.102 | 0.135 | |
| b5 | 2.59 | 3.38 | 0.102 | 0.133 | |
| С | 0.38 | 0.89 | 0.015 | 0.035 | |
| c1 | 0.38 | 0.84 | 0.015 | 0.033 | |
| D | 19.71 | 20.70 | 0.776 | 0.815 | 3 |
| D1 | 13.08 | - | 0.515 | - | 4 |

| SYMBOL | MILLIN | IETERS | INC | HES | NOTES |
|---------|----------|--------|-------|-------|-------|
| OTWIDOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| D2 | 0.51 | 1.35 | 0.020 | 0.053 | |
| E | 15.29 | 15.87 | 0.602 | 0.625 | 3 |
| E1 | 13.46 | - | 0.53 | - | |
| е | 5.46 | BSC | 0.215 | BSC | |
| ØK | 0.2 | 0.254 | |)10 | |
| L | 14.20 | 16.10 | 0.559 | 0.634 | |
| L1 | 3.71 | 4.29 | 0.146 | 0.169 | |
| ØΡ | 3.56 | 3.66 | 0.14 | 0.144 | |
| Ø P1 | - | 7.39 | - | 0.291 | |
| Q | 5.31 | 5.69 | 0.209 | 0.224 | |
| R | 4.52 | 5.49 | 0.178 | 0.216 | |
| S | 5.51 BSC | | 0.217 | BSC | |
| | | | | | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension c and Q

Revision: 20-Apr-17 **1** Document Number: 95542

Legal Disclaimer Notice



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